



SEMiX® 3p

## SEMiX443KD16p

### Features

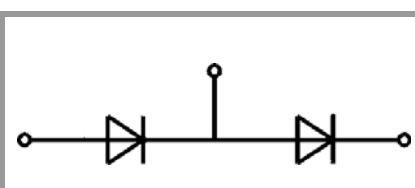
- Rectifier PEP technology for enhanced power and environmental robustness
- $T_{jmax} = 175^{\circ}\text{C}$
- NTC temperature sensor
- Press-fit pins as auxiliary contacts
- Terminal height 17 mm
- UL recognised file no. E63532

### Typical Applications\*

- Input Bridge Rectifier for AC/DC motor control
- Power supply

### Remarks

- Product reliability results are valid for  $T_j = 150^{\circ}\text{C}$
- $V_{isol}$  between temperature sensor and power section is only 2500V
- For storage and case temperature with TIM see document "TP(\*) SEMiX 3p"



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### Absolute Maximum Ratings

Symbol	Conditions		Values	Unit
Recitifier Diode				
I <sub>FAV</sub>	T <sub>j</sub> = 175 °C	T <sub>c</sub> = 85 °C	585	A
	sin. 180	T <sub>c</sub> = 100 °C	511	A
I <sub>FSM</sub>	10 ms	T <sub>j</sub> = 25 °C	10000	A
		T <sub>j</sub> = 150 °C	8200	A
i <sup>2</sup> t	10 ms	T <sub>j</sub> = 25 °C	500000	A <sup>2</sup> s
		T <sub>j</sub> = 150 °C	336200	A <sup>2</sup> s
V <sub>RSM</sub>			1700	V
V <sub>RRM</sub>			1600	V
T <sub>j</sub>			-40 ... 175	°C
Module				
T <sub>stg</sub>			-40 ... 125	°C
V <sub>isol</sub>	AC sinus 50Hz	1 min	4000	V
		1 s	4800	V

### Characteristics

Symbol	Conditions	min.	typ.	max.	Unit
<b>Diode</b>					
$V_F$	$I_F = 1428\text{ A}$	$T_j = 25^{\circ}\text{C}$	1.13	1.42	V
	chiplevel	$T_j = 150^{\circ}\text{C}$	1.07	1.38	V
$V_{(TO)}$	chiplevel	$T_j = 25^{\circ}\text{C}$	0.89	1.09	V
		$T_j = 150^{\circ}\text{C}$	0.73	0.92	V
$r_T$	chiplevel	$T_j = 25^{\circ}\text{C}$	0.17	0.23	$\text{m}\Omega$
		$T_j = 150^{\circ}\text{C}$	0.24	0.32	$\text{m}\Omega$
$I_{RD}$	$T_j = 125^{\circ}\text{C}$ , $V_{RD} = V_{RRM}$			3	mA
$R_{th(j-c)}$	sin. 180	per diode		0.11	K/W
					K/W
$R_{th(c-s)}$	per Diode ( $\lambda_{grease} = 0.81\text{ W}/(\text{m}^2\text{K})$ )		0.037		K/W
$R_{th(c-s)}$	per Diode, pre-applied phase change material		0.019		K/W
<b>Module</b>					
$R_{CC'+EE'}$	measured per switch	$T_c = 25^{\circ}\text{C}$	0.4		$\text{m}\Omega$
		$T_c = 125^{\circ}\text{C}$	0.5		$\text{m}\Omega$
$R_{th(c-s)1}$	calculated without thermal coupling		0.019		K/W
$R_{th(c-s)2}$	including thermal coupling, $T_s$ underneath module ( $\lambda_{grease} = 0.81\text{ W}/(\text{m}^2\text{K})$ )		0.024		K/W
$R_{th(c-s)2}$	including thermal coupling, $T_s$ underneath module, pre-applied phase change material		0.013		K/W
$M_s$	to heat sink (M5)	3		6	Nm
$M_t$	to terminals (M6)	3		6	Nm
$a$				$5 * 9.81$	$\text{m/s}^2$
$w$				360	g
<b>Temperature Sensor</b>					
$R_{100}$	$T_c = 100^{\circ}\text{C}$ ( $R_{25} = 5\text{ k}\Omega$ )		$493 \pm 5\%$		$\Omega$
$B_{100/125}$	$R(T) = R_{100} \exp[B_{100/125}(1/T - 1/T_{100})]$ ; $T[\text{K}]$		$3550 \pm 2\%$		K

1) PCB hole specification see  
Mounting Instructions SEMiX press-fit

This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, chapter IX.

## **\*IMPORTANT INFORMATION AND WARNINGS**

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